

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	$I_D$
-60V	55mΩ@-10V	-5A
	70mΩ@-4.5V	

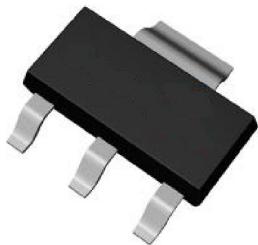
## Feature

- Split gate trench MOSFET technology
- Extremely low switching loss
- Excellent stability and uniformity
- Suffix “-Q1” for AEC-Q101

## Application

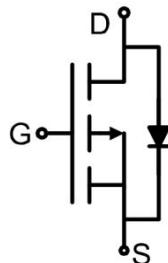
- Power management
- Load switch

## Package

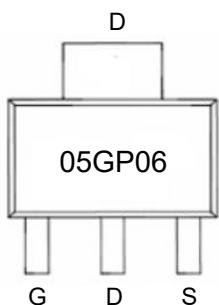


SOT-223

## Circuit diagram



## Marking



**Absolute maximum ratings (T<sub>A</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V <sub>DS</sub>	-60	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	-5	A
Continuous Drain Current (T <sub>A</sub> =100°C)	I <sub>D</sub> (100°C)	-3	A
Pulsed Drain Current <sup>1)</sup>	I <sub>DM</sub>	-25	A
Power Dissipation <sup>2)</sup>	P <sub>D</sub>	1	W
Thermal Resistance from Junction to Ambient <sup>3)</sup>	R <sub>θJA</sub>	120	°C/W
Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature	T <sub>STG</sub>	-55 ~ +150	°C

**Electrical characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-60			V
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -60V, V <sub>GS</sub> = 0V			-1	μA
Gate-body leakage current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V			±100	nA
Gate threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	-1.5	-2	-3	V
Drain-source on-resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10V, I <sub>D</sub> = 5A		40	55	mΩ
		V <sub>GS</sub> = -4.5V, I <sub>D</sub> = 4A		50	70	
<b>Dynamic characteristics<sup>4)</sup></b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V, f = 1MHz		1050		pF
Output Capacitance	C <sub>oss</sub>			380		
Reverse Transfer Capacitance	C <sub>rss</sub>			20		
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = -30V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -5A		18.7		nC
Gate-Source Charge	Q <sub>gs</sub>			4.7		
Gate-Drain Charge	Q <sub>gd</sub>			3		
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = -30V, V <sub>GS</sub> = -10V, I <sub>D</sub> = -5A, R <sub>GEN</sub> = 2.2Ω		7.5		nS
Turn-on rise time	t <sub>r</sub>			40		
Turn-off delay time	t <sub>d(off)</sub>			43		
Turn-off fall time	t <sub>f</sub>			55		
<b>Source-Drain Diode characteristics</b>						
Diode Continuous Current	I <sub>S</sub>				-5	A
Diode Forward voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -5A			-1.2	V
Reverse recover time	t <sub>rr</sub>	I <sub>F</sub> = -5A, di/dt = 100A/us		20		nS
Reverse recovery charge	Q <sub>rr</sub>			8		nC

Notes:

- 1) Repetitive rating; pulse width limited by max. junction temperature.
- 2) P<sub>d</sub> is based on max. junction temperature, using junction-case and junction-ambient thermal resistance.
- 3) The value of R<sub>θJA</sub> is measured with the device mounted on the minimum recommend pad size, in the still air environment with T<sub>A</sub> = 25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

## Typical Characteristics

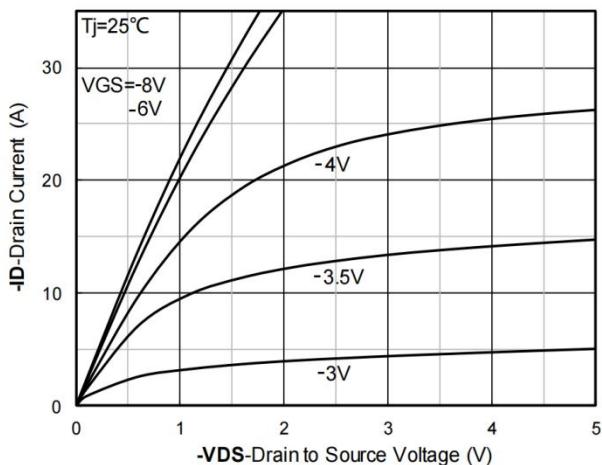


Figure 1. Output Characteristics

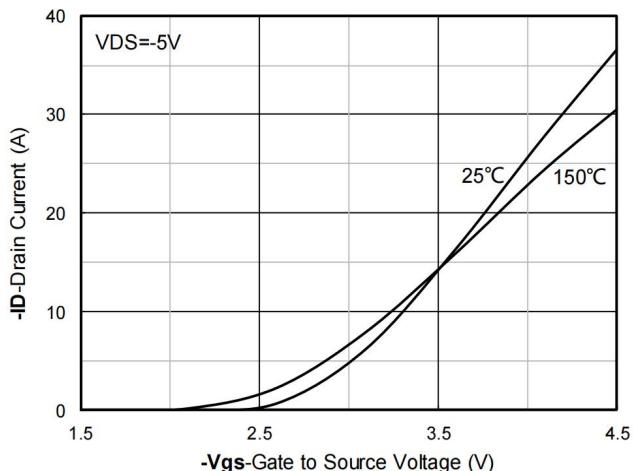


Figure 2. Transfer Characteristics

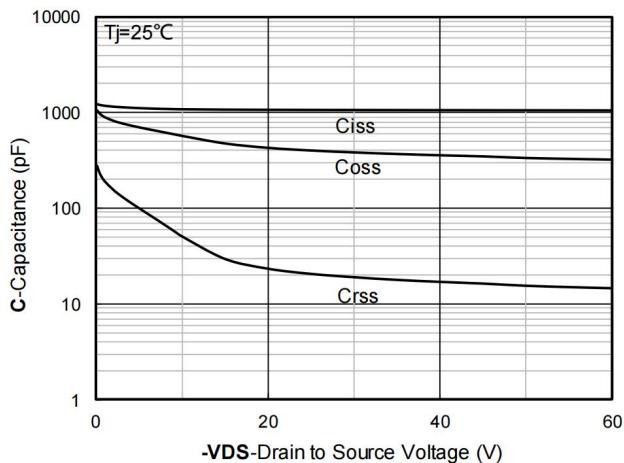


Figure 3. Capacitance Characteristics

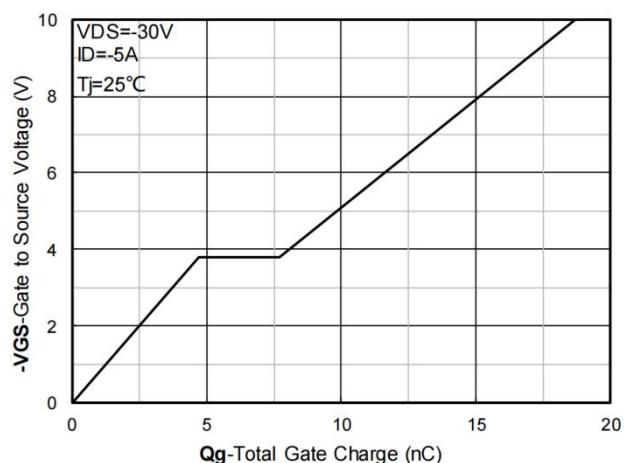


Figure 4. Gate Charge

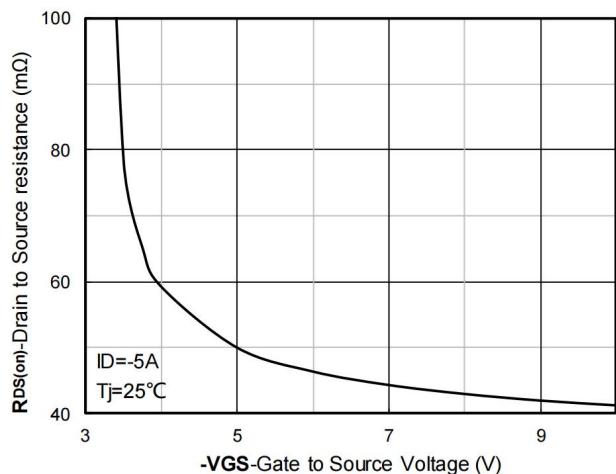


Figure 5. On-Resistance vs Gate to Source Voltage

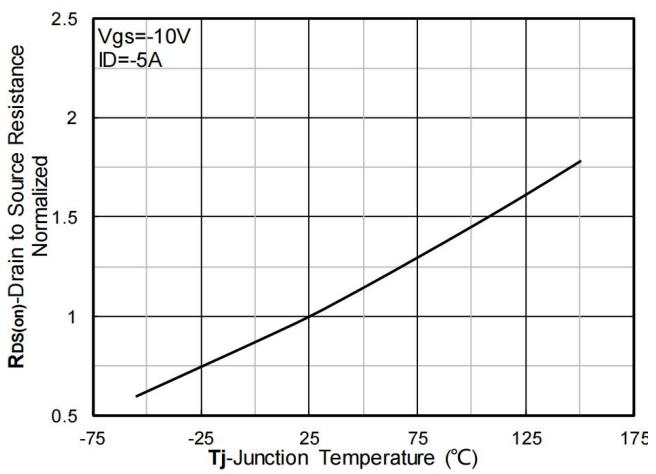


Figure 6. Normalized On-Resistance

## Typical Characteristics

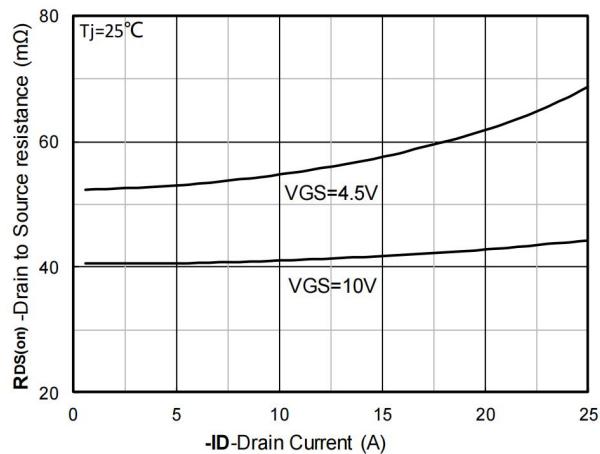


Figure 7.  $R_{DS(on)}$  VS Drain Current

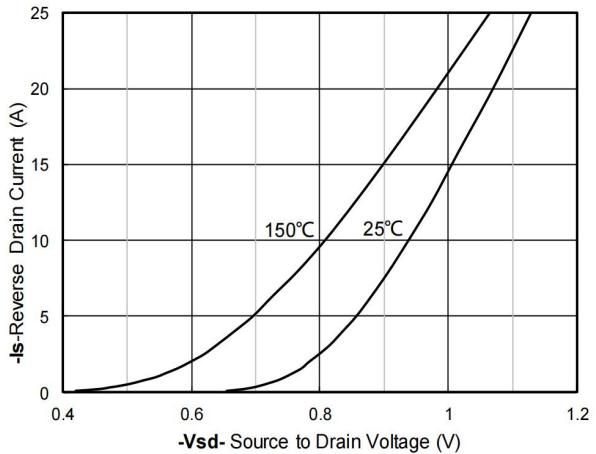


Figure 8. Forward characteristics of reverse diode

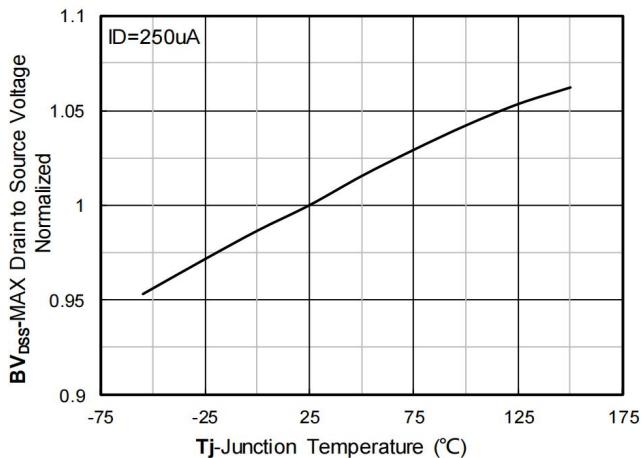


Figure 9. Normalized breakdown voltage

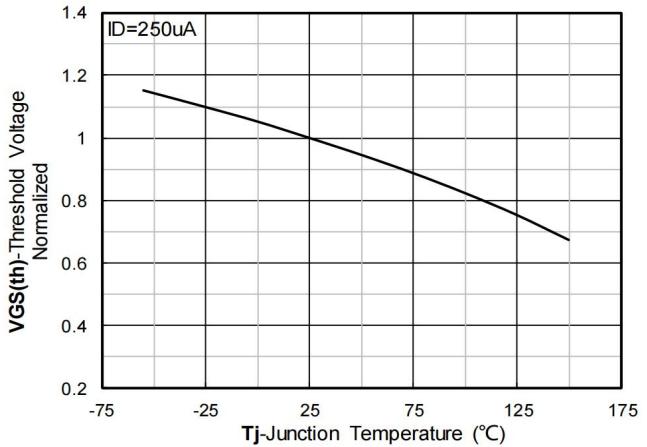


Figure 10. Normalized Threshold voltage

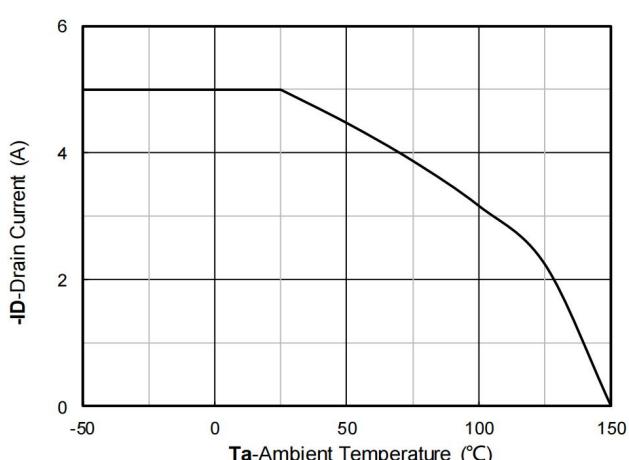


Figure 11. Current dissipation

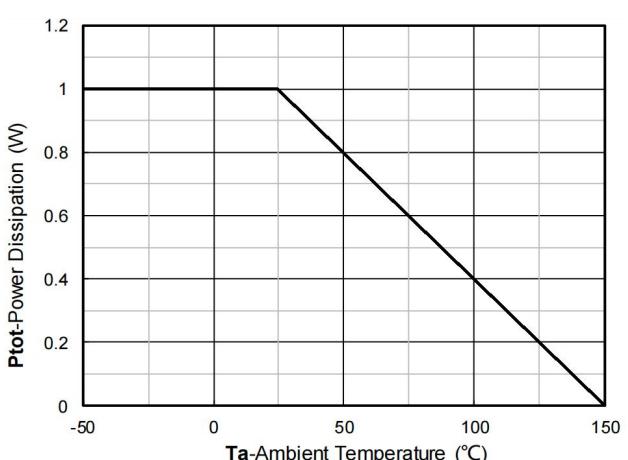


Figure 12. Power dissipation

### Typical Characteristics

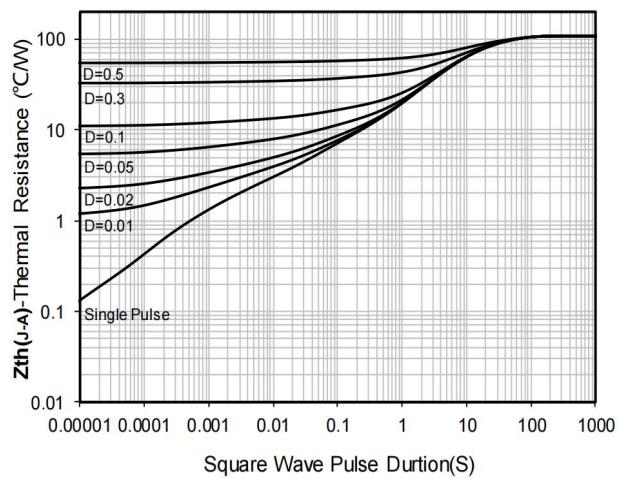


Figure 13. Maximum Transient Thermal Impedance

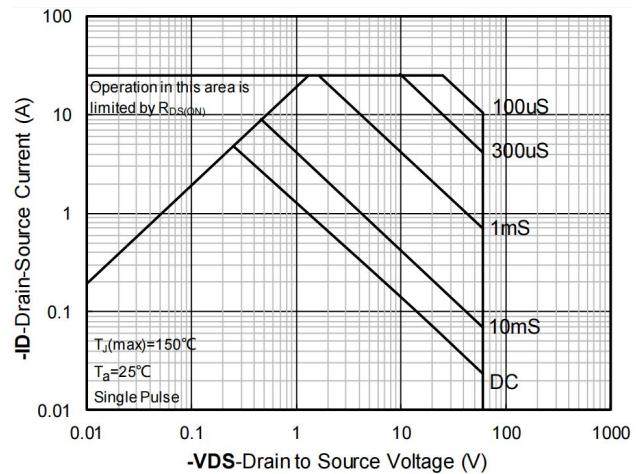
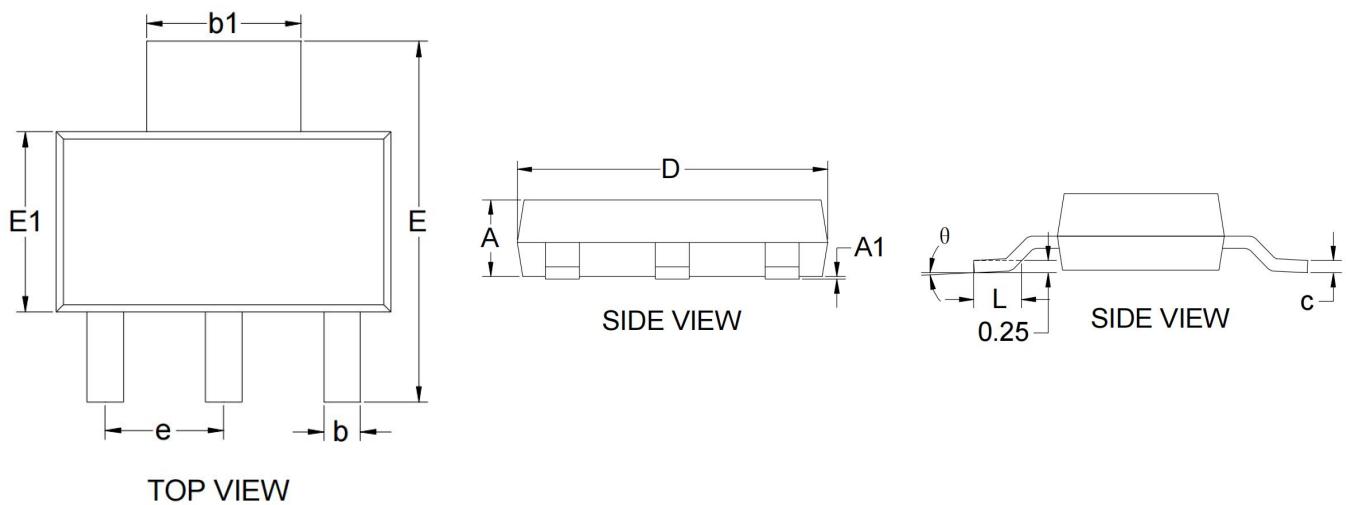


Figure 14. Safe Operation Area

**SOT-223 Package Information**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.500	1.700	0.059	0.067
A1	0.020	0.100	0.000	0.004
b	0.660	0.840	0.026	0.033
b1	2.900	3.100	0.114	0.122
c	0.230	0.350	0.009	0.014
D	6.300	6.700	0.248	0.264
E	6.700	7.300	0.264	0.287
E1	3.300	3.700	0.130	0.146
e	2.200	2.400	0.087	0.094
L	0.750	1.250	0.030	0.049
θ	0°	10°	0°	10°